ABSOLUTE MAXIMUM RATINGS

(All Voltages Referenced to V)	
V+	44V
GND	25V
V _L	(GND -0.3V) to (V+ +0.3V)
Digital Inputs, V _S , V _D (Note 1)(\	
	(whichever occurs first)
Continuous Current (any terminal)	30mA
Peak Current	
(pulsed at 1ms, 10% duty cycle ma	ıx)100mA

.842mW
.696mW
.800mW
.457mW
538mW
+70°C
+85°C
+125°C
+150°C
+300°C

Note 1: Signals on S, D, or IN exceeding V+ or V- are clamped by internal diodes. Limit forward current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—Dual Supplies

(V+ = 15V, V- = -15V, VL = 5V, VGND = 0V, VINH = 2.4V, VINL = 0.8V, TA = TMIN to TMAX, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP (Note 2)	MAX	UNITS
SWITCH								
Analog Signal Range	Vanalog	(Note 3)			-15		15	V
		V+ = 13.5V,	T _A = +25°C	C, D		17	45	
Drain-Source On-Resistance	RDS(ON)	$V = -13.5V$, $V_D = \pm 8.5V$,	1A = +25 C	А		17	30	Ω
On-nesistance		$I_S = -10 \text{mA}$	T _A = T _{MIN} to T	MAX			45	
On-Resistance Match Between Channels	ADDO(OLD	V+ = 15V, V- = -15V,	T _A = +25°C				3	Ω
(Note 4)	ΔR _{DS(ON)}	$V_D = \pm 10V$, $I_S = -10mA$	T _A = T _{MIN} to T	MAX			5	52
On-Resistance Flatness	DEL ATIONS	V+ = 15V, V- = -15V,	T _A = +25°C				4	Ω
(Note 4)	nFLAT(ON)	$V_D = \pm 5V, 0V,$ $I_S = -10mA$	$T_A = T_{MIN}$ to T	MAX			6	22
		V+ = 16.5V,	T _A = +25°C	C, D, A	-0.25	-0.10	0.25	
Source Off-Leakage Current (Note 7)	Is(OFF)	V- = -16.5V, $V_D = \pm 15.5V,$	T _A = T _{MIN} to	C, D	-5		5	nA
(1007)		$V_S = \pm 15.5V$	T _{MAX}	А	-10		10	
D : 0".		V+ = 16.5V,	T _A = +25°C	C, D, A	-0.25	-0.10	0.25	
Drain Off-Leakage Current (Note 7)	ID(OFF)	V = -16.5V, $V_D = \pm 15.5V,$ $V_S = \pm 15.5V$	T _A = T _{MIN} to	C, D	-5		5	nA
	1 2 1 7		T _{MAX}	А	-10		10	
	Drain On-Leakage Current + (Note 7)	V- = -16.5V,	T _A = +25°C	C, D, A	-0.4	-0.1	0.4	
Drain On-Leakage Current (Note 7)			T _A = T _{MIN} to	C, D	-20		20	nA
	$V_S = \pm 15.5V$ $V_S = \pm 15.5V$ TMAX		А	-40		40		

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ELECTRICAL CHARACTERISTICS—Dual Supplies (continued) $(V+ = 15V, V- = -15V, V_L = 5V, V_{GND} = 0V, V_{INH} = 2.4V, V_{INL} = 0.8V, T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP (Note 2)	MAX	UNITS
INPUT	1						I.
Input Current with Input Voltage High	linh	IN = 2.4V, all others = 0.8V		-0.500	0.005	0.500	μΑ
Input Current with Input Voltage Low	I _{INL}	IN = 0.8V, all others =	2.4V	-0.500	0.005	0.500	μΑ
SUPPLY	•			1			
Power-Supply Range				±4.5		±20.0	V
Positive Supply Current	I+	All channels on or off, V+ = 16.5V,	T _A = +25°C	-1	0.0001	1	μΑ
Toolave Supply Surrent		V- = -16.5V, V _{IN} = 0V or 5V	TA = TMIN to TMAX	-5		5	μ
Negative Supply Current	-	All channels on or off, V+ = 16.5V,	T _A = +25°C	-1	-0.0001	1	μΑ
		V- = -16.5V, V _{IN} = 0V or 5V	TA = TMIN to TMAX	-5		5	'
Logic Supply Current	l _L	All channels on or off, $V+ = 16.5V$,	T _A = +25°C	-1	0.0001	1	μA
Logic oupply durient	"	V = -16.5V, $V_{IN} = 0V \text{ or } 5V$	TA = TMIN to TMAX	-5		——— μA 5	
Ground Current	IGND	All channels on or off, V+ = 16.5V,	T _A = +25°C	-1	-0.0001	1	μΑ
Ground Current	IGND	V- = -16.5V, $V_{IN} = 0V \text{ or } 5V$	$T_A = T_{MIN}$ to T_{MAX}	-5		5	μΑ
DYNAMIC							
Turn-On Time	ton	$V_D = \pm 10V$,	T _A = +25°C		110	175	ns
Taill Oil Time	TON	Figure 2	$T_A = T_{MIN}$ to T_{MAX}			220	113
Turn-Off Time	toff	$V_D = \pm 10V$,	T _A = +25°C		100	145	ns
Turn-On Time	IOFF	Figure 2	$T_A = T_{MIN}$ to T_{MAX}			160	115
Break-Before-Make Time Delay	t _D	DG413 only, $R_L = 300\Omega$, $C_L = 35pF$, Figure 3	T _A = +25°C		25		ns
Charge Injection (Note 3)	Q	$C_L = 1.0$ nF, $V_{GEN} = 0$ V, $R_{GEN} = 0$ Ω, Figure 4	T _A = +25°C		5	10	рС
Off-Isolation (Note 5)	OIRR	$R_L = 50\Omega$, $C_L = 5pF$, f = 1MHz, Figure 5	T _A = +25°C		68		dB
Crosstalk (Note 6)		$R_L = 50\Omega$, $C_L = 5pF$, f = 1MHz, Figure 6	T _A = +25°C		85		dB
Source Off-Capacitance	C _{S(OFF)}	f = 1MHz, Figure 7	T _A = +25°C		9		pF
Drain Off-Capacitance	CD(OFF)	f = 1MHz, Figure 7	T _A = +25°C		9		pF
Drain On-Capacitance	C _{D(ON)} + C _{S(ON)}	f = 1MHz, Figure 8	TA = +25°C		35		pF

MIXIM

ELECTRICAL CHARACTERISTICS—Single Supply

(V+ = 12V, V- = 0V, VL = 5V, VGND = 0V, VINH = 2.4V, VINL = 0.8V, TA = TMIN to TMAX, unless otherwise noted.)

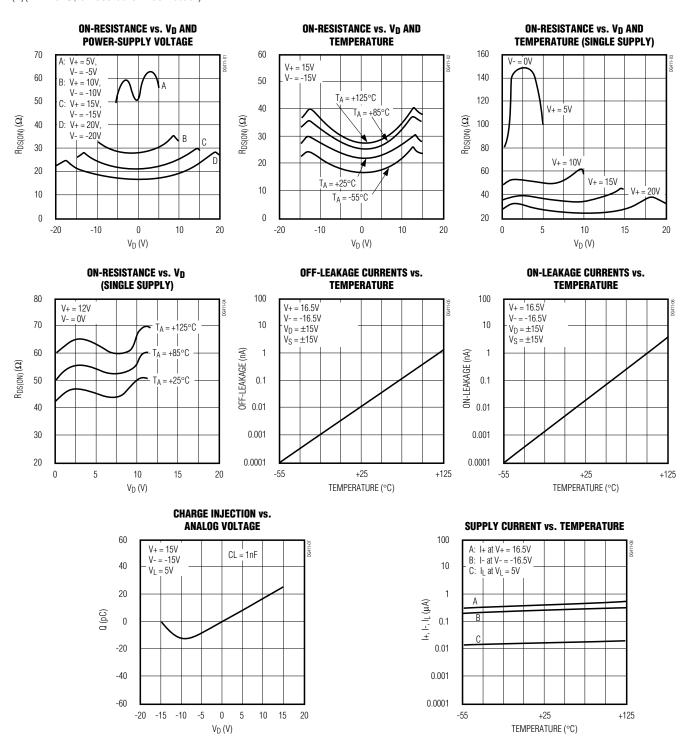
PARAMETER	SYMBOL	CONDITIONS		MIN	TYP (Note 2)	MAX	UNITS
SWITCH							l
Analog Signal Range	VANALOG	(Note 3)		0		12	V
Drain-Source On-Resistance	Proven	V+ = 10.8V, $V_D = 3.8V,$	T _A = +25°C		40	80	Ω
Drain-Source On-Nesistance	R _{DS} (ON)	$I_S = -10 \text{mA}$	TA = TMIN to TMAX			100	52
SUPPLY							
Positive Supply Current	l+	All channels on or off, V+ = 13.2V,	T _A = +25°C	-1	0.0001	1	
rosilive Supply Current	1+	V+=13.2V, $V_{IN}=0V \text{ or } 5V$	TA = TMAX	-5		5	μA
N .: 0 . I 0 . I		All channels on or off,	T _A = +25°C	-1	0.0001	1	
Negative Supply Current	-	V+ = 13.2V, $V_{IN} = 0V \text{ or } 5V$	T _A = T _{MAX}	-5		5	μA 5
		All channels on or off,	T _A = +25°C	-1	0.0001	1	
Logic Supply Current	lL	$V_L = 5.25V$, $V_{IN} = 0V$ or $5V$	T _A = T _{MAX}	-5		5	μA
0 10 1		All channels on or off,	T _A = +25°C	-1	-0.0001	1	
Ground Current	IGND	IGND $V_L = 5.25V$, $V_{IN} = 0V \text{ or } 5V$ $T_A = T_{MAX}$	T _A = T _{MAX}	-5	5	5	- μΑ
DYNAMIC							l
Turn-On Time	ton	Vs = 8V,	T _A = +25°C		175	250	ns
Tain on time	TON	Figure 2	$T_A = T_{MIN}$ to T_{MAX}			315	110
Turn-Off Time	toff	Vs = 8V,	T _A = +25°C		95	125	ns
		Figure 2	TA = TMIN to TMAX			140	
Break-Before-Make Time Delay	t _D	DG413 only, $R_L = 300\Omega$, $C_L = 35pF$, Figure 3	T _A = +25°C		25		ns
Charge Injection (Note 3)	Q	$C_L = 1.0nF,$ $V_{GEN} = 0V,$ $R_{GEN} = 0V,$ Figure 4	T _A = +25°C		5	10	рС

- **Note 2:** The algebraic convention, where the most negative value is a minimum and the most positive value a maximum, is used in this data sheet.
- Note 3: Guaranteed by design.
- Note 4: ΔRON = ΔRON max ΔRON min. On-resistance match between channels and flatness are guaranteed only with bipolar-supply operation. Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured at the extremes of the specified analog signal range.
- **Note 5:** Off-Isolation = $20log(V_D/V_S)$, $V_D = output$, $V_S = input$ to off switch. See Figure 5.
- Note 6: Between any two switches. See Figure 6.
- Note 7: Leakage parameters Is(OFF), ID(OFF), and ID(ON) are 100% tested at the maximum-rated hot temperature and guaranteed by correlation at +25°C.

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Typical Operating Characteristics

 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$



Pin Description

Р	IN	NAME	FUNCTION	
DIP/SO/TSSOP	QFN	INAIVIE		
1, 16, 9, 8	15, 14, 7, 6	IN1-IN4	Input	
2, 15, 10, 7	16, 13, 8, 5	D1-D4	Analog Switch Drain Terminal	
3, 14, 11, 6	1, 12, 9, 4	S1-S4	Analog Switch Source Terminal	
4	2	V-	Negative-Supply Voltage Input	
5	3	GND	Ground	
12	10	VL	Logic Supply Voltage	
13	11	V+	Positive-Supply Voltage Input—Connected to Substrate	
_	_	EP	Exposed Paddle (QFN Only). Connect EP to V+.	

Applications Information

Operation with Supply Voltages Other Than 15V

Using supply voltages other than 15V will reduce the analog signal range. The DG411/DG412/DG413 switches operate with ± 4.5 V to ± 20 V bipolar supplies or with a ± 10 V to ± 30 V single supply; connect V- to 0V when operating with a single supply. Also, all device types can operate with unbalanced supplies such as ± 24 V and ± 5 V. V_L must be connected to ± 5 V to be TTL compatible, or to V+ for CMOS-logic level inputs. The Typical Operating Characteristics graphs show typical on-resistance with ± 15 V, ± 10 V, and ± 5 V supplies. (Switching times increase by a factor of two or more for operation at ± 5 V.)

Overvoltage Protection

Proper power-supply sequencing is recommended for all CMOS devices. Do not exceed the absolute maximum ratings because stresses beyond the listed ratings may cause permanent damage to the devices. Always sequence V+ on first, followed by V_L, V-, and logic inputs. If power-supply sequencing is not possible, add two small, external signal diodes in series with supply pins for overvoltage protection (Figure 1).

Adding diodes reduces the analog signal range to 1V below V+ and 1V below V-, without affecting low switch resistance and low leakage characteristics. Device operation is unchanged, and the difference between V+ and V- should not exceed +44V.

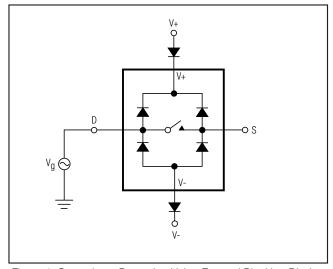


Figure 1. Overvoltage Protection Using External Blocking Diodes

Timing Diagrams/Test Circuits

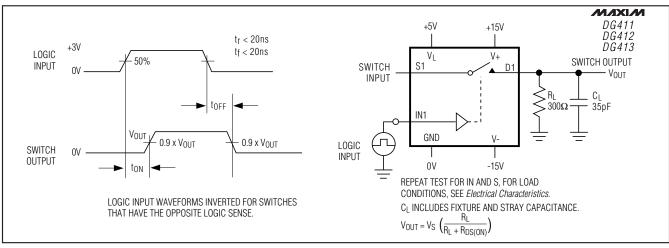


Figure 2. Switching-Time

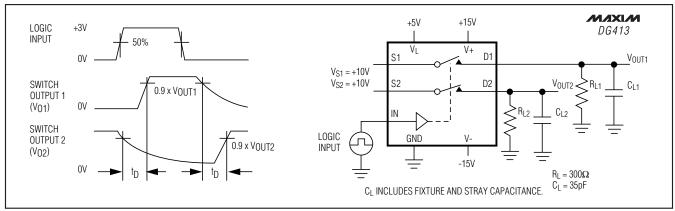


Figure 3. DG413 Break-Before-Make

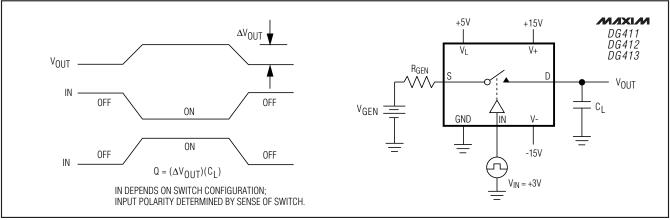


Figure 4. Charge-Injection

/N/IXI/N ______

Timing Diagrams/Test Circuits (continued)

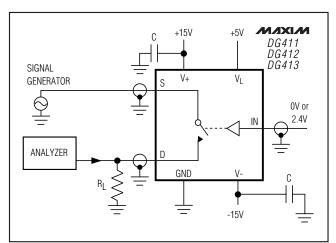


Figure 5. Off-Isolation

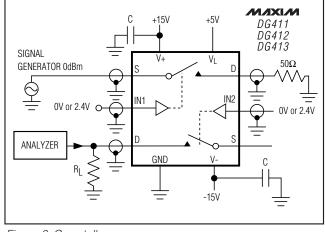


Figure 6. Crosstalk

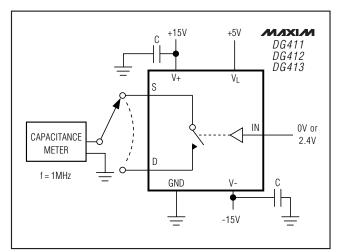


Figure 7. Channel Off-Capacitance

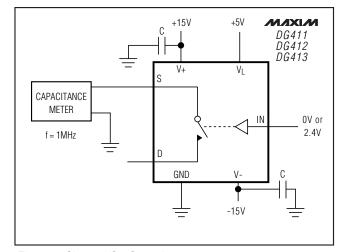


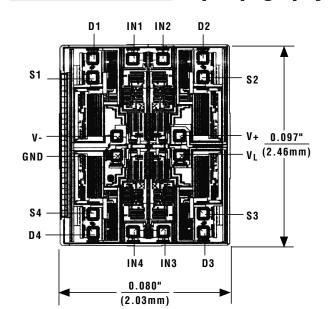
Figure 8. Channel On-Capacitance

Chip Topography

Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE
DG411EGE	-40°C to +85°C	16 QFN-EP*
DG411DJ	-40°C to +85°C	16 Plastic DIP
DG411DY	-40°C to +85°C	16 Narrow SO
DG411DK	-40°C to +85°C	16 CERDIP
DG411AK	-55°C to +125°C	16 CERDIP**
DG411MY/PR	-55°C to +125°C	16 SO***
DG411MY/PR-T	-55°C to +125°C	16 SO***
DG412CJ	0°C to +70°C	16 Plastic DIP
DG412CUE	0°C to +70°C	16 TSSOP
DG412EUE	-40°C to +85°C	16 TSSOP
DG412CY	0°C to +70°C	16 Narrow SO
DG412C/D	0°C to +70°C	Dice†
DG412DJ	-40°C to +85°C	16 Plastic DIP
DG412EGE	-40°C to +85°C	16 QFN-EP*
DG412DY	-40°C to +85°C	16 Narrow SO
DG412DK	-40°C to +85°C	16 CERDIP
DG412AK	-55°C to +125°C	16 CERDIP**
DG412MY/PR	-55°C to +125°C	16 SO***
DG412MY/PR-T	-55°C to +125°C	16 SO***
DG413CJ	0°C to +70°C	16 Plastic DIP
DG413CUE	0°C to +70°C	16 TSSOP
DG413EUE	-40°C to +85°C	16 TSSOP
DG413CY	0°C to +70°C	16 Narrow SO
DG413C/D	0°C to +70°C	Dice†
DG413EGE	-40°C to +85°C	16 QFN-EP*
DG413DJ	-40°C to +85°C	16 Plastic DIP
DG413DY	-40°C to +85°C	16 Narrow SO
DG413DK	-40°C to +85°C	16 CERDIP
DG413AK	-55°C to +125°C	16 CERDIP**

[†]Contact factory for dice specifications.

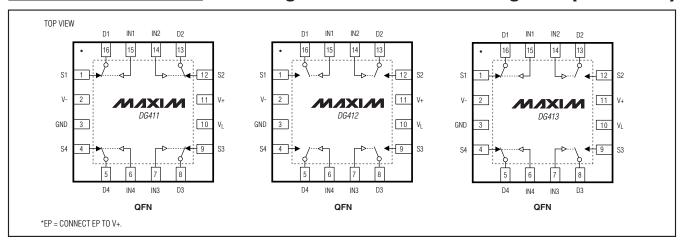


^{*}EP = Exposed pad.

^{**}Contact factory for availability and processing to MIL-STD-883B.

^{***}Contact factory for availability.

Pin Configurations/Functional Diagrams (continued)



Package Information

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
16 QFN-EP	G1655-3	<u>21-0091</u>
16 Plastic DIP	P16-1	<u>21-0043</u>
16 TSSOP	U16-2	<u>21-0066</u>
16 CERDIP	J16-3	<u>21-0045</u>
16 Narrow SO	S16-1	<u>21-0041</u>
16 SO	S16-1	21-0041

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
6	9/07	Addition of exposed pad information	1, 6, 9, 14, 15
7	9/08	Addition of rugged plastic information	1, 9

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